cc:

PATENT APPLICATION TRANSMITTAL LETTER

(Large Entity)

Docket No. 8292.013

TO THE ASSISTANT COMMISSIONER FOR PATENTS

Transmitted herewith for filing under 35 U.S.C. 111 and 37 C.F.R. 1.53 is the patent application of:

SATO, Takaya; SHIMIZU, Tatsuo

For: MULTI-LAYER ELECTRODE STRUCTURE AND METHOD OF MANUFACTURING SAME

Enclosed are: Certificate of Mailing with Express Mail Mailing Label No. 12 sheets of drawings. A certified copy of a application. Declaration Signed. Unsigned. Power of Attorney Information Disclosure Statement Preliminary Amendment Other: Spec., Claims & Abstract						
CLAIMS AS FILED						
For	#Filed	#Allowed	#Extra		Rate	Fee
Total Claims	53	- 20 =	33	x	\$18.00	\$594.00
Indep. Claims	19	- 3 =	16	х	\$80.00	\$1,280.00
Multiple Dependent Claims (check if applicable) ☐ \$0.00						
BASIC FEE						\$710.00
TOTAL FILING FEE						\$2,584.00
☐ Credit any☐ Charge ar☐ Charge th	r is hereby author. A duplicate of e amount of overpayment. A additional filing e issue fee set in a 37 C.F.R. 1.31	orized to charge a opy of this sheet as g fees required u n 37 C.F.R. 1.18	is enclosed. Is filing fee. Inder 37 C.F.I at the mailing Ma Reg Lin 655	R. 1.16 g of the tthew V g No. 36	and 1.17. Notice of Allowance, Market Allowance Signature V. Stavish	iite

Bethesda, MD 20817 (301)896-0600